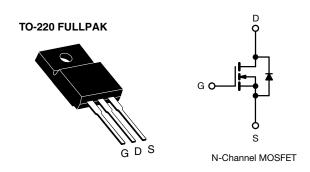


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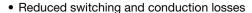
E Series Power MOSFET



PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	700)	
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	0.6	
Q _g max. (nC)	48		
Q _{gs} (nC)	6		
Q _{gd} (nC)	11		
Configuration	Sing	le	

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF6N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	650	V
Gate-Source Voltage			V_{GS}	± 30	7 v
Continuous Drain Current (T, I = 150 °C) e	\/ at 10 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		7	
Continuous Drain Current (1) = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	Ι _D	5	Α
Pulsed Drain Current ^a			I _{DM}	18	
Linear Derating Factor				0.63	W/°C
Single Pulse Avalanche Energy b			E _{AS}	56	mJ
Maximum Power Dissipation			P_D	31	W
Operating Junction and Storage Temperature Range	е		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$T_{J} = 1$	125 °C	dV/dt	37	V/ns
Reverse Diode dV/dt ^d			av/at	27	V/IIS
Soldering Recommendations (Peak temperature) c For 10 s			300	°C	
Mounting Torque M3 screw			0.6	Nm	

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.
- e. Limited by maximum junction temperature.



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	4.0	G/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Cata Causaa Laakaaa			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μΑ
Zava Cata Valtaga Dvain Coverent	1	V _{DS} =	= 650 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 _{fs}	V _{DS}	s = 30 V, I _D = 3 A	-	2	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	820	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	40	-	1
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MHz		4	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0V 500V V 0V		-	36	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _{DS} = 0 \	/ to 520 V, V _{GS} = 0 V	-	117	-	
Total Gate Charge	Qg			-	24	48	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 3 A, V_{DS} = 520 V$	-	6	-	nC
Gate-Drain Charge	Q _{gd}	7		-	11	-	
Turn-On Delay Time	t _{d(on)}			-	14	28	
Rise Time	t _r	V_{DD}	= 520 V, I _D = 3 A,	-	12	24	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, R_g = 9.1 Ω	-	30	60	ns
Fall Time	t _f	7		-	20	40	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.4	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	7	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction	₹ □	-	-	18	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 3 A, V _{GS} = 0 V	-	-	1.3	V
Reverse Recovery Time	t _{rr}	-		-	237	-	ns
Reverse Recovery Charge	Q _{rr}		25 °C, I _F = I _S = 3 A,	-	2.2	-	μC
Reverse Recovery Current	I _{RRM}		100 A/ μ s, V _R = 25 V	_	16	-	A

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

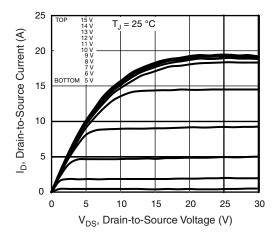


Fig. 1 - Typical Output Characteristics

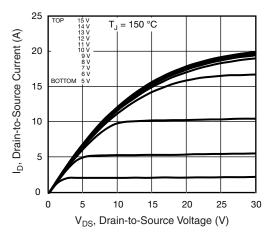


Fig. 2 - Typical Output Characteristics

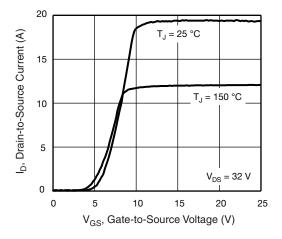


Fig. 3 - Typical Transfer Characteristics

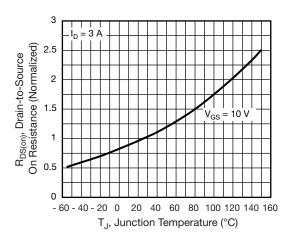


Fig. 4 - Normalized On-Resistance vs. Temperature

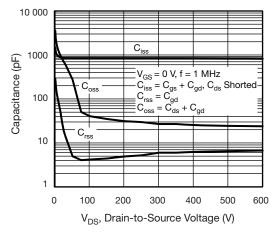


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

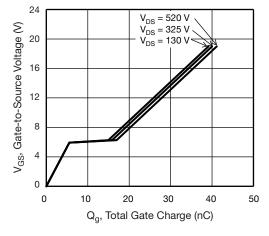


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



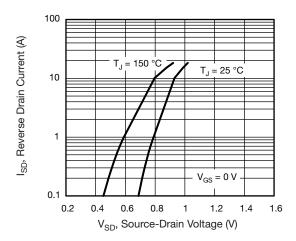


Fig. 7 - Typical Source-Drain Diode Forward Voltage

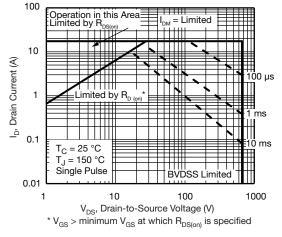


Fig. 8 - Maximum Safe Operating Area

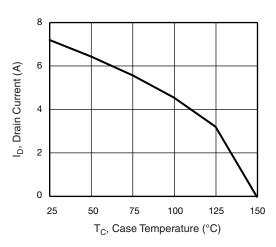


Fig. 9 - Maximum Drain Current vs. Case Temperature

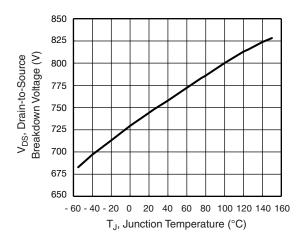


Fig. 10 - Temperature vs. Drain-to-Source Voltage

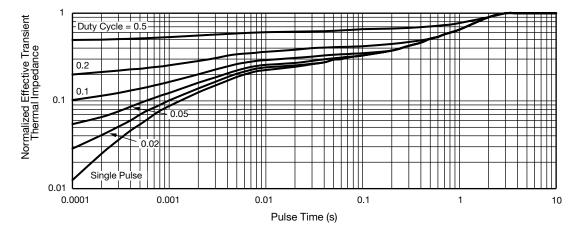


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



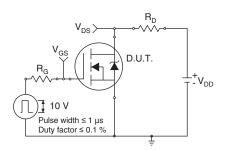


Fig. 12 - Switching Time Test Circuit

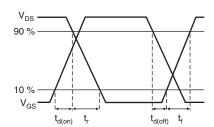


Fig. 13 - Switching Time Waveforms

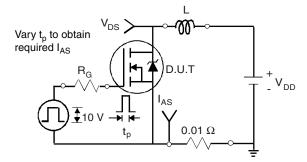


Fig. 14 - Unclamped Inductive Test Circuit

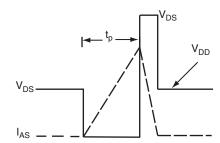


Fig. 15 - Unclamped Inductive Waveforms

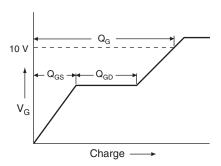


Fig. 16 - Basic Gate Charge Waveform

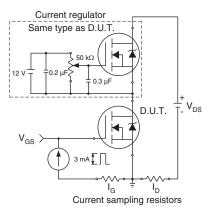
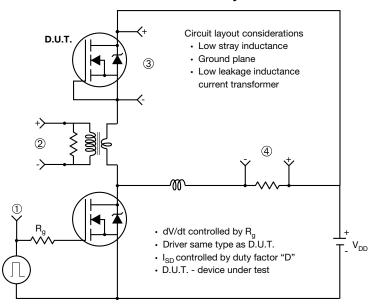


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



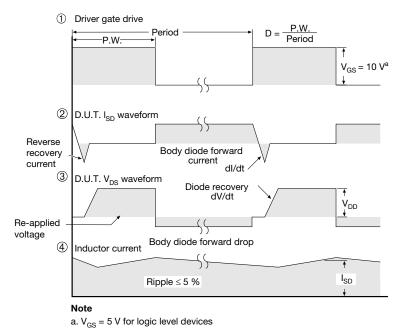


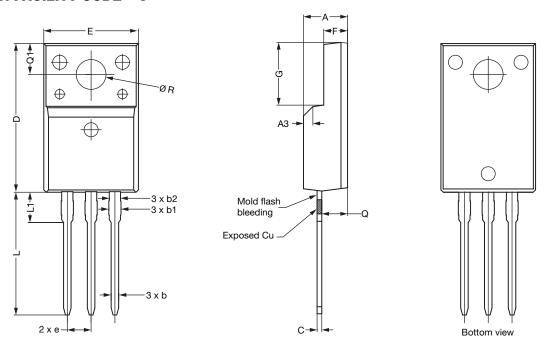
Fig. 18 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

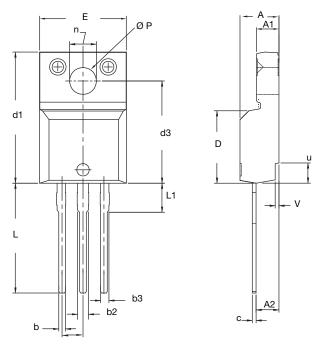


		MILLIMETERS			
DIM.	MIN.	NOM.	MAX.		
Α	4.60	4.70	4.80		
b	0.70	0.80	0.91		
b1	1.20	1.30	1.47		
b2	1.10	1.20	1.30		
С	0.45	0.50	0.63		
D	15.80	15.87	15.97		
е	2.54 BSC				
E	10.00	10.10	10.30		
F	2.44	2.54	2.64		
G	6.50	6.70	6.90		
L	12.90	13.10	13.30		
L1	3.13	3.23	3.33		
Q	2.65	2.75	2.85		
Q1	3.20	3.30	3.40		
ØR	3.08	3.18	3.28		

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



	MILLIMETERS		MILLI	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
Е	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100 BSC			
L	13.200	13.730	0.520	0.541		
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØΡ	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

ECN: E19-0180-Rev. D, 08-Apr-2019 DWG: 5972

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- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
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- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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Vishay

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